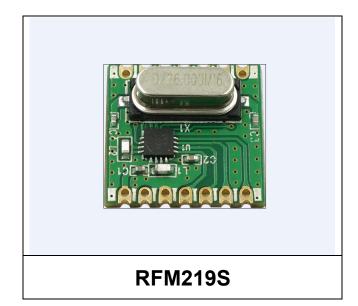


Features

- Embedded EEPROM
 - Very Easy Development with RFPDK
 - · All Features Programmable
- Frequency Range: 300 to 960 MHz
- FSK, GFSK and OOK Demodulation
- Symbol Rate: 0.1 to 100 ksps
- Sensitivity: -109 dBm @ 9.6 ksps, FSK, 868M Hz
- 4-wire SPI Interface
- Direct, Buffer and Packet Mode Supported
- Configurable Data Handler and 32-Byte FIFO
- Manchester Decoding and Data De-Whitening
- Supply Voltage: 1.8 to 3.6 V
- Low Power Consumption: 5.7 mA
- Low Sleep Current
 - 60 nA when Sleep Timer Off
 - 440 nA when Sleep Timer on
- RoHS Compliant
- Module Size:16*16*5.0mm

Descriptions

The RFM219S is an ultra low power, high performance, OOK and (G)FSK receiver for various 300 to 960 MHz wireless applications. It is part of the HOPERF NextGenRFTM family, which includes a complete line of transmitters, receivers and transceivers. All features can be configured either off-line by programming or on-line registers writing. The configuration file to be written, into the registers is generated by the smart RFPDK. The RFM219S operates from a supply voltage of 1.8 V to 3.6V, when it is always on, it consumes only 5.7 mA current while achieving -109 dBm receiving sensitivity (FSK, 9.6 ksps symbol rate, 868.35 MHz), and only 60 nA sleep current for superior battery life. The device supports packet handling, 32-byte FIFO, Manchester decoding and data de-whitening for the received data processing. Besides the demodulated data and the sync clock, the device can also, send out the power-on reset, the system clock, as well as 2 configurable interrupts for the external device. RFM219S receiver together with the CMT211xA transmitter enables a powerful RF link.



Applications

- Low-Cost Consumer Electronics Applications
- Home and Building Automation
- Infrared Receiver Replacements
- Industrial Monitoring and Controls
- Remote Automated Meter Reading
- Remote Lighting Control System
- Wireless Alarm and Security Systems
- Remote Keyless Entry (RKE)



Abbreviations

Abbreviations used in this data sheet are described below.

| ADC | Analog to Digital Converter | NP0 | Negative-Positive-Zero |
|--------|--|-----------|-------------------------------------|
| AFC | Automatic-Frequency-Control | NC | Not Connected |
| AGC | Automatic Gain Control | оок | On-Off Keying |
| AN | Application Notes | PC | Personal Computer |
| BER | Bit Error Rate | PCB | Printed Circuit Board |
| BOM | Bill of Materials | PLL | Phase Lock Loop |
| BSC | Basic Spacing between Centers | PN9 | Pseudorandom Noise 9 |
| ВТ | bandwidth-time product | POR | Power On Reset |
| BW | Bandwidth | PUP | Power Up |
| CRC | Cyclic Redundancy Check | QFN | Quad Flat No-lead |
| DC | Direct Current | RESV | Reserved |
| EEPROM | Electrically Erasable Programmable Read-Only | RF | Radio Frequency |
| | Memory | RFPDK | RF Products Development Kit |
| ESD | Electro-Static Discharge | RoHS | Restriction of Hazardous Substances |
| ESR | Equivalent Series Resistance | RSSI | Received Signal Strength Indicator |
| Ext | Extended | Rx | Receiving, Receiver |
| FIFO | First In First Out | SAR | Successive Approximation Register |
| FSK | Frequency-Shift Keying | SMD | Surface Mounted Devices |
| GFSK | Gauss frequency Shift Keying | SPI | Serial Port Interface |
| GPO | General Purpose Output | SR | Symbol Rate |
| HEX | Hexadecimal | STBY | Standby |
| IF | Intermediate Frequency | TH | Threshold |
| LNA | Low Noise Amplifier | Tx | Transmission, Transmitter |
| LO | Local Oscillator | Тур | Typical |
| LPOSC | Low Power Oscillator | USB | Universal Serial Bus |
| Max | Maximum | VCO | Voltage Controlled Oscillator |
| MCU | Microcontroller Unit | WOR | Wake-On Radio |
| Min | Minimum | XOSC | Crystal Oscillator |
| MOQ | Minimum Order Quantity | XTAL/Xtal | Crystal |
| | • | | - y |



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1. Electrical Characteristics

VDD = 3.3 V, T_{OP} = 25 °C, F_{RF} = 868.35 MHz, sensitivities are measured in receiving a PN9 sequence and matching to 50 Ω impedance, with the BER of 0.1%. All measurements are performed using the board RFM219S-EM V1.0, unless otherwise noted.

1.1 Recommended Operation Conditions

Table 2. Recommended Operation Conditions

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--------------------------|-----------------|------------|-----|-----|-----|-------|
| Operation Voltage Supply | V_{DD} | | 1.8 | | 3.6 | V |
| Operation Temperature | T _{OP} | | -40 | | 85 | ℃ |
| Supply Voltage Slew Rate | | | 1 | | | mV/us |

1.2 Absolute Maximum Ratings

Table 3. Absolute Maximum Ratings^[1]

| Parameter | Symbol | Conditions | Min | Max | Unit |
|---------------------------|------------------|---------------------------|------|-----------------------|------|
| Supply Voltage | V_{DD} | | -0.3 | 3.6 | V |
| Interface Voltage | V _{IN} | | -0.3 | V _{DD} + 0.3 | V |
| Junction Temperature | TJ | | -40 | 125 | °C |
| Storage Temperature | T _{STG} | | -50 | 150 | °C |
| Soldering Temperature | T _{SDR} | Lasts at least 30 seconds | | 255 | °C |
| ESD Rating ^[2] | | Human Body Model (HBM) | -2 | 2 | kV |
| Latch-up Current | | @ 85 ℃ | -100 | 100 | mA |

Notes:

- [1]. Stresses above those listed as "absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.
- [2]. The RFM219S is high-performance RF integrated circuits with VCON/P pins having an ESD rating < 2 kV HBM. Handling and assembly of this device should only be done at ESD-protected workstations.



Caution! ESD sensitive device. Precaution should be used when handling the device in order to prevent permanent damage.

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1.3 Receiver Specifications

Table 4. Receiver Specifications

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|---------------------------------------|-------------------------|--|-----|------|-----|-------|
| Frequency Range | F_RF | | 300 | | 960 | MHz |
| O make at Date | O.D. | OOK demodulation | 0.1 | | 40 | ksps |
| Symbol Rate | SR | (G)FSK demodulation | 0.1 | | 100 | ksps |
| Deviation | F _{DEV} | (G)FSK | 1 | | 200 | kHz |
| Bandwidth-Time Product | ВТ | | - | 0.5 | - | - |
| | S _{315-OOK} | 315 MHz, SR = 1 ksps | | -114 | | dBm |
| 0014.0 | S _{433.92-OOK} | 433.92 MHz, SR = 1 ksps | | -113 | | dBm |
| OOK Sensitivity | S _{868.35-OOK} | 868.35 MHz, SR = 1 ksps | | -110 | | dBm |
| | S _{915-OOK} | 915 MHz, SR = 1 ksps | | -109 | | dBm |
| | S _{315-FSK} | 315 MHz, SR = 9.6 ksps, F _{DEV} = 19.2 kHz | | -112 | | dBm |
| (O) FOK Consitinity | S _{433.92-FSK} | 433.92 MHz, SR = 9.6 ksps, F _{DEV} = 19.2 kHz | | -111 | | dBm |
| (G) FSK Sensitivity | S _{868.35-FSK} | 868.35 MHz, SR = 9.6 ksps, F _{DEV} = 19.2 kHz | | -109 | | dBm |
| | S _{915-FSK} | 915 MHz, SR = 9.6 ksps, F _{DEV} = 19.2 kHz | | -109 | | dBm |
| Saturation Input Signal Level | P _{LVL} | | | 10 | | dBm |
| | I _{DD-OOK} | 315 MHz, OOK | | 3.5 | | mA |
| OOK Ward in a Ourse of | | 433.92 MHz, OOK | | 3.8 | | mA |
| OOK Working Current | | 868.35 MHz, OOK | | 5.2 | | mA |
| | | 915 MHz, OOK | | 5.4 | | mA |
| | | 315 MHz, FSK | | 4.0 | | mA |
| FCK Marking Current | | 433.92 MHz, FSK | | 4.3 | | mA |
| FSK Working Current | I _{DD-FSK} | 868.35 MHz, FSK | | 5.7 | | mA |
| | | 915 MHz, FSK | | 5.9 | | mA |
| Class Current | | When sleep timer is turned on | | 440 | | nA |
| Sleep Current | I _{SLEEP} | When sleep timer is turned off | | 60 | | nA |
| Frequency Resolution | F _{RES} | | | 24.8 | | Hz |
| Frequency Synthesizer Settle Time | T _{LOCK} | From XOSC settled | | 150 | | us |
| | | SR = 1 ksps, ±1 MHz offset, CW interference | | 52 | | dB |
| Blocking Immunity | BI | SR = 1 ksps, ±2 MHz offset, CW interference | | 74 | | dB |
| BIOCKING IIIIIIIIIIIII | ы | SR = 1 ksps, ±10 MHz offset, CW interference | | 75 | | dB |
| Image Rejection Ratio | IMR | IF = 280 kHz | | 35 | | dB |
| Input 3 rd Order Intercept | IIP3 | Two tone test at 1 MHz and 2 MHz offset | | -25 | | dBm |
| Point | III-3 | frequency. Maximum system gain settings | | -20 | | וווטט |
| Receiver Bandwidth | BW | | 50 | | 500 | kHz |
| Receiver Start-up Time | T _{START-UP} | From power up to receive, in Always Receive Mode | | 7.3 | | ms |
| Receiver Wake-up Time | T _{WAKE-UP} | From sleep to receive, in Duty-Cycle Receive Mode | | 0.61 | | ms |



1.4 Crystal Oscillator

Table 5. Crystal Oscillator Specifications

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|----------------------------------|-------------------|------------|-----|-----|-----|------|
| Crystal Frequency ^[1] | F _{XTAL} | | 26 | 26 | 26 | MHz |
| Crystal Tolerance ^[2] | | | | ±20 | | ppm |
| Load Capacitance | C _{LOAD} | | 10 | 15 | 20 | pF |
| Crystal ESR | Rm | | | | 60 | Ω |
| XTAL Startup Time[3] | t _{XTAL} | | | 400 | | us |

Notes

- [1]. The RFM219S can directly work with external 26 MHz reference clock input to XIN pin (a coupling capacitor is required) with peak-to-peak amplitude of 0.3 to 0.7 V.
- [2]. This is the total tolerance including (1) initial tolerance, (2) crystal loading, (3) aging, and (4) temperature dependence. The acceptable crystal tolerance depends on RF frequency and channel spacing/bandwidth.
- [3]. This parameter is to a large degree crystal dependent.

1.5 LPOSC

Table 6. LPOSC Specifications

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--|------------------------|-------------------|-----|-------|-----|------|
| Calibrated Frequency ^[1] | F _{LPOSC} | | | 1 | | kHz |
| Frequency Accuracy | | After calibration | | 1 | | % |
| Temperature Coefficient ^[2] | | | | -0.02 | | %/°C |
| Supply Voltage Coefficient[3] | | | | +0.5 | | %/V |
| Initial Calibration Time | t _{LPOSC-CAL} | | | 4 | | ms |

Notes:

- [1]. The LPOSC is automatically calibrated to the crystal oscillator during the PUP state, and is periodically calibrated since then.
- [2]. Frequency drifts when temperature changes after calibration.
- [3]. Frequency drifts when supply voltage changes after calibration.



2. Pin Descriptions

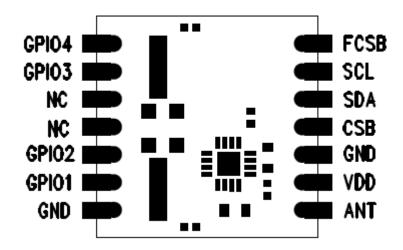


Figure 2. Pin Diagram

Table 6. RFM219S Pin Descriptions

| Pin Number | Name | I/O | Descriptions | |
|------------|------|-----|--|--|
| 1 | ANT | ı | RF signal input to the LNA | |
| 2 | VDD | I | Power supply input, 1.8 V to 3.6 V | |
| 3,14 | GND | I | Ground | |
| 4 | CSB | ı | 4-wire SPI chip select input, active low, internally pulled high | |
| 5 | SDA | Ю | 4-wire SPI data input and output | |
| 6 | SCL | ı | 4-wire SPI clock input, internally pulled low | |
| 7 | FCSB | I | 4-wire SPI FIFO select input, active low. leave floating when programming the EEPROM, internally pulled high | |
| 8 | GPO4 | 0 | General purpose output, options are: DOUT (Default), INT1, INT2 and DCLK | |
| 9 | GPO3 | 0 | General purpose output, options are: CLKO (Default), INT1, INT2 and DOUT | |
| 10, 11 | NC | | Not Connected | |
| 12 | GPO2 | 0 | General purpose output, options are: INT1 (Default), INT2 and DCLK | |
| 13 | GPO1 | 0 | General purpose output, options are: nRSTO (Default), INT1, INT2 and DOUT | |



3. Typical Performance Characteristics

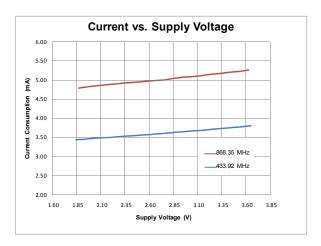


Figure 3. Current vs. Voltage, $F_{RF} = 433.92 / 868.35 \text{ MHz}$, OOK, SR = 1 ksps

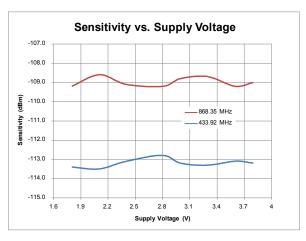


Figure 5. Sensitivity vs. Supply Voltage, SR = 1 ksps, OOK, BER = 0.1%

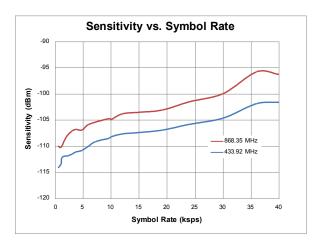


Figure 7. Sensitivity vs. SR, F_{RF} = 433.92 / 868.35 MHz, OOK, V_{DD} = 3.3 V, BER = 0.1%

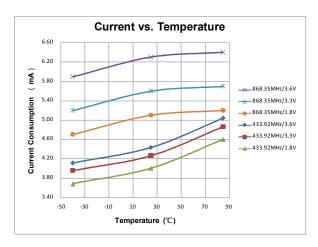


Figure 4. Current vs. Temperature, F_{RF} = 433.92 / 868.35 MHz, FSK, SR = 1 ksps

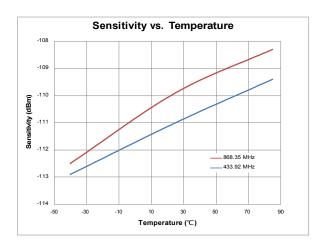


Figure 6. Sensitivity vs. Temperature, F_{RF} = 433.92 / 868.35 MHz, FSK, V_{DD} = 3.3 V, SR = 1 ksps, BER = 0.1%

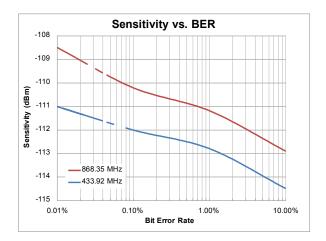


Figure 8. Sensitivity vs. BER, F_{RF} = 433.92 / 868.35 MHz, V_{DD} = 3.3 V, SR = 1 ksps



4. Typical Application Schematic

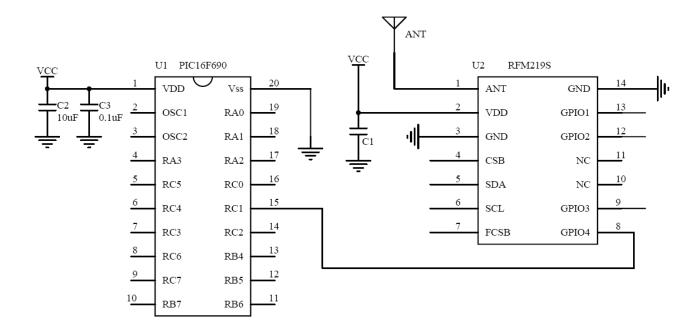


Figure 9: Typical Application Schematic



5. Functional Descriptions

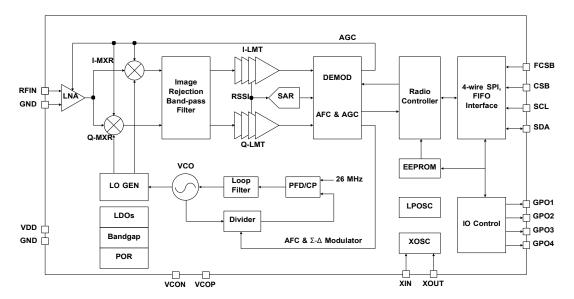


Figure 10. Functional Block Diagram

5.1 Overview

The RFM219S is an ultra low power, high performance, OOK and (G)FSK RF receiver for various 300 to 960 MHz wireless applications. It is part of the HOPERF NextGenRFTM family, which includes a complete line of transmitters, receivers and transceivers. The device is based on a fully integrated, low-IF receiver architecture. The low-IF architecture facilitates a very low external component count and does not suffer from powerline - induced interference problems. The RF signal coming from antenna is amplified, down-converted, filtered and further amplified in analog domain before sending into the digital demodulator. The synthesizer contains a VCO and a low noise fractional-N PLL with an output frequency resolution of 24.8 Hz. The VCO operates at 2x the Local Oscillator (LO) frequency to reduce spurious emissions. Every analog block is calibrated on each Power-on Reset (POR) to the internal reference voltage. The calibration helps the device to finely work under different temperatures and supply voltages. The baseband filtering and demodulation is done by the digital demodulator. The device supports packet handling, 32-byte FIFO, Manchester decoding and data de-whitening for the received data processing. Besides the demodulated data and the sync clock, the device can also send out the power-on reset, the system clock, as well as 2 configurable interrupts for the external device.

The 4-wire SPI interface is not only used for configuring the device by programming the EEPROM, but also controlling the device by the external MCU. All features can be configured either by off-line EEPROM programming or on-line registers writing. The configuration file to be written into the registers is generated by the smart RFPDK. The RF Frequency, symbol rate and other product features are all configurable. This saves the cost and simplifies the design, development and manufacture. The RFM219S operates from 1.8 to 3.6 V so that it can finely work with most batteries to their useful power limits. The receive current is only 5.7 mA while achieving -109 dBm receiving sensitivity (FSK @ 868.35 MHz F_{RF}, 9.6 ksps SR), and only 60 nA sleep current for superior battery life. The RFM219S receiver together with the CMT2119A transmitter enables a powerful RF link.

5.2 Modulation, Frequency and Symbol Rate

The RFM219S supports OOK demodulation with the symbol rate from 0.1 to 40 ksps and (G)FSK demodulation with the symbol rate from 0.1 to 100 ksps. It continuously covers the frequency range from 300 to 960 MHz, including the license free ISM frequency band around 315 MHz, 433.92 MHz, 868.35 MHz and 915 MHz. The internal frequency synthesizer contains a



high-purity VCO and a low noise fractional-N PLL with an output frequency resolution of 24.8 Hz. See the table below for the demodulation, frequency and symbol rate information.

| Parameter | Value | Unit |
|----------------------|--------------------|------|
| Demodulation | OOK, FSK and GFSK | - |
| Frequency | 300 to 960 | MHz |
| Frequency Resolution | 24.8 | Hz |
| O mah al Data | OOK: 0.1 to 40 | ksps |
| Symbol Rate | (G)FSK: 0.1 to 100 | ksps |

Table 9. Modulation, Frequency and Symbol Rate

5.3 Embedded EEPROM and RFPDK

The RFPDK is a PC application developed to help the user to configure the HOPERF NextGenRFTM products in the most intuitional way. The user only needs to connect the USB Programmer between the PC and the device, fill in/select the proper value of each parameter on the RFPDK, and click the "Burn" button to program the configurations into the device. The configurations of the device will then remain unchanged until the next programming. No external MCU control is required in the application program.

The RFPDK also allows the user to save the active configuration into a list by clicking on the "List" button, so that the saved configuration can be directly reloaded from the list in the future. Furthermore, it supports exporting the configuration into a hexadecimal file by clicking on the "Export" button. This file can be used to burn the same configuration into a large amount of devices during the mass production, or used as an HEX file to load into the external MCU program for on-line configuration using registers. See the figure below for the accessing of the EEPROM.

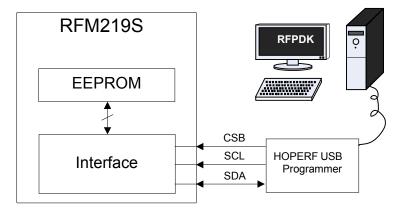


Figure 11. Accessing Embedded EEPROM

For more details of the HOPERF USB Programmer and the RFPDK, please refer to "AN103 CMT211xA-221xA One-Way RF Link Development Kits Users Guide".

5.4 All Configurable Options

Besides the demodulation, frequency and symbol rate, more options can be used to customize the device. The following is a table of all the configurable options. On the RFPDK, the Basic Mode only contains a few options allowing the user to perform easy and fast configurations. The Advanced Mode shows all the options that allow the user to customize the device in a deeper level. The options in "Basic Mode" are a subset of that in the "Advanced Mode".

All the details of these parameters will be given in the document "AN138 RFM219S Configuration Guideline". In this datasheet,

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only main features are introduced. Remember that there are two methods to load all these parameters into the device:

Off-line Configuration

Use the RFPDK to directly burn (program) them into the embedded EEPROM of the device. The configuration retains until the next programming. This is called the off-line configuration.

On-line Configuration

Use the RFPDK to export a HEX file of these parameters, load the content of the HEX file into the external MCU program then writes the content into the Configuration Bank of the User Registers (See Chapter 5.11) at the beginning of the applications. The configuration retains until the power down of the device. This is called the on-line configuration.

Either of these method works. To save the external MCU's effort, method 1 can be used. To save the EEPROM programming step in the manufacturing stage, method 2 can be used. The table below shows all the configurable parameters.

Table 10. Configurable Parameters on RFPDK

| Category | Parameters | Descriptions | Default | Mode |
|-----------------------|-----------------------|---|----------------------|-------------------|
| | Frequency | The receive radio frequency, the range is from 300 to 960 MHz, with resolution of 0.01 MHz. | 868.35 MHz | Basic Advanced |
| | Demodulation | The demodulation type, the options are: OOK or (G)FSK demodulation. | (G)FSK | Basic Advanced |
| DE | Symbol Rate | The receiver symbol rate, the range is from 0.1 to 40 ksps for OOK and from 0.1 to 100.0 ksps for (G)FSK, with resolution of 0.1 ksps. | 2.4 ksps | Basic Advanced |
| RF Settings | Squelch TH | The threshold of the squelch circuit to suppress the noise, the range is from 0 to 255. | 0 | Basic Advanced |
| | Xtal Tol. Rx BW | The sum of the crystal frequency tolerance of the Tx and the Rx, the range is from 0 to ±300 ppm. And the calculated BW is configured and displayed. | ±10 ppm 100 kHz | Basic Advanced |
| | Xtal Stabilizing Time | Time for the device to wait for the crystal to get settled after power up. The options are: 78, 155, 310, 620, 1240 or 2480 us. | 310 us | Basic Advanced |
| | Operation Mode | This determines that the chip works in Active mode by using off-line configuration or works in Passive mode by using on-line configuration. | Passive | Basic Advanced |
| | Sleep Timer | This turns on/off the sleep timer. | Off | Basic Advanced |
| | Sleep Time | The sleep time has the range from 3 to 134,152,192 ms. It is only available when Active mode is selected or Sleep Timer is on in Passive mode. | 10 ms | Basic Advanced |
| Operation Settings | Rx Timer | This turns on/off the receive timer. | Off | Basic Advanced |
| | Rx Time | The receive time has the range from 0.04 to 2,683,043.00 ms. It is only available when Active mode is selected or Rx Timer is on in Passive mode. | 1 ms | Basic Advanced |
| | Rx Time Ext | The extended receive time has the range from 0.04 to 2,683,043.00 ms. It is only available when Wake-On Radio is turned on and the Rx Timer is turned on. | 200.00 ms | Advanced |
| | Rx Early-Exit | Turn on/off the Rx early exit function, the options are: on or off. | Off | Advanced |



| Category | Parameters | Descriptions | Default | Mode |
|----------|---------------------------|--|-------------------------|-------------------|
| | State After Rx Exit | This defines the state to which the device will switch after the Rx Early Exit. The options are: STBY or TUNE. | STBY | Advanced |
| | System Clock Output | Turn on/off the system clock output on CLKO, the options are: on or off. | Off | Advanced |
| | System Clock Frequency | The system clock output frequency, the options are: 13.000, 6.500, 4.333, 3.250, 2.600, 2.167, 1.857, 1.625, 1.444, 1.300, 1.182, 1.083, 1.000, 0.929, 0.867, 0.813, 0.765, 0.722, 0.684, 0.650, 0.619, 0.591, 0.565, 0.542, 0.520, 0.500, 0.481, 0.464, 0.448, 0.433, 0.419 or 0.406 MHz. It is only available when System Clock Output is turned on. | 6.500 MHz | Advanced |
| | Wake-On Radio | Turn on/off the wake-on radio function, the options are: on or off. | Off | Advanced |
| | Wake-On Condition | The condition to wake on the radio, the option is: Extended by Preamble, or Extended by Preamble then Sync Word. It is only available when Wake-On Radio is turned on. | Extended by Preamble | Advanced |
| | Demod Method | The OOK demodulation methods, the options are: Peak TH, or Fixed TH. | Peak TH | Advanced |
| | Fixed Demod TH | The threshold value when the Demod Method is "Fixed TH", the minimum input value is the value of Squelch Threshold set on the RFPDK, the maximum value is 255. | 50 | Advanced |
| оок | Peak Drop | Turn on/off the RSSI peak drop function, the options are on, or off. | On | Advanced |
| Settings | Peak Drop Step | The RSSI peak drop step size, the options are: 1, 2, 3, 5, 6, 9, 12 or 15. | 1 | Advanced |
| | Peak Drop Rate | The RSSI peak drop rate, the options are: 1 step/4 symbols, 1 step/2 symbols, 1 step/1 symbol, or 1 step/0.5 symbol. | 1 step/4 symbols | Advanced |
| | AGC | Automatic Gain Control, the options are: on or off. | On | Advanced |
| | Deviation | The (G)FSK frequency deviation. The minimum value of the deviation is equal to Xtal Tolerance (ppm) x Frequency (MHz) / 0.7. The maximum value of deviation is equal to 220 kHz - Xtal Tolerance (ppm) x Frequency (MHz). | 35 kHz | Basic Advanced |
| (G)FSK | Sync Clock Type | This parameter allows the user to select the method to perform the clock data recovery. The options are: tracing or counting. | Counting | Advanced |
| Settings | Data Representation | To select whether the frequency "F-high" represent data 0 or 1. The options are: 0: F-high 1:F-low, or 0: F-low 1:F-high. | 0: F-low 1:F-high | Basic Advanced |
| | Rising Relative TH | This is the relative threshold to trigger the (G)FSK demodulation. It is measured in terms of RSSI code. The options are: 0, 3, 6, 9, 12, 15, 18, 21, 24, 27, 30, 36, 42, 54, 66, or 90. | 21 | Advanced |



| Category | Parameters | Descriptions | Default | Mode |
|--------------------|------------------------|---|--------------|-------------------|
| | Falling Relative TH | This is the relative threshold to shut down the (G)FSK demodulation. It is measured in terms of RSSI code. The range is from 0 to 255. | 255 | Advanced |
| | AFC | Turn on/off the Automatic Frequency Control function. The options are: On or Off. | On | Advanced |
| | Data Mode | The data acquisition mode, the options are: Direct, Buffer or Packet. | Packet | Basic Advanced |
| | Packet Type | The device can support two packet types. The options are: Fixed length or Variable length. | Fixed Length | Basic Advanced |
| | FIFO Threshold | This defines the FIFO threshold that once it is reached, an interrupt is generated to notify the external MCU. The range is from 1 to 32, in terms of the FIFO address. | 32 | Basic Advanced |
| | De-Whitening Seed | This parameter is only available when DC-Free Data Decode is not set to "None". The initial seed for the data de-whitening polynomial. The range is from 0 to 255. | NA | Basic Advanced |
| | DC-Free Decode | The options of DC-free data decoding are None, Manchester 1 (01=one, 10=zero), Manchester 2 (10=one, 01=zero), or Data De-whitening. | None | Basic Advanced |
| | Preamble | The size of the valid preamble, the options are: None, 1-byte, 2-byte, 3-byte, or 4-byte. | 2-byte | Basic Advanced |
| | Sync Size | The size of the Sync Word, the options are: None, 1-byte, 2-byte, 3-byte, or 4-byte. This option cannot be set to "None" in buffer mode. | 3-byte | Basic Advanced |
| Decode Settings | Sync Value | This parameter is only available when Sync Size is not set to "None". It defines the value of the Sync Word, the range is from 0 to 2 ^N -1, where N is determined by Sync Size. For example, if Sync Size is 1-byte, N is 8; if Sync Size is 2-byte, N is 16, etc. | 0 | Basic Advanced |
| | Sync Tolerance | The number of bits tolerated for the Sync Word recognition. The options are: None, 1 Error, 2 Errors or 3 Errors. | None | Basic Advanced |
| | Node ID Options | The options for the Node ID detection are: None, Detect Node ID, Detect Node ID and 0x00, or Detect Node ID, 0x00 and 0xFF | None | Basic Advanced |
| | Node ID Value | This parameter is only available when the Node ID Options is not set to "None". It defines the value of the Node ID. The range is from 0 to 255. | NA | Basic Advanced |
| | Data Length | This defines the number of bytes of data in a fixed length packet. The range is from 0 to 32. | 32 | Basic Advanced |
| | CRC Options | The options for the CRC are: None, CCITT or IBM. | None | Basic Advanced |
| | CRC Seed | This parameter is only available when CRC Options is not set to "None". It defines the initial seed for the CRC polynomial. The range is from 0 to 65535. | NA | Basic Advanced |



5.5 Internal Blocks Description

5.5.1 RF Front-end and AGC

The RFM219S features a low-IF receiver. The RF front-end of the receiver consists of a Low Noise Amplifier (LNA), I/Q mixer and a wide-band power detector. Only a low-cost inductor and a capacitor are required for matching the LNA to any common used antennas. The input RF signal induced on the antenna is amplified and down-converted to the IF frequency for further processing.

By means of the wide-band power detector and the attenuation networks built around the LNA, the Automatic Gain Control (AGC) loop regulates the RF front-end's gain to get the best system linearity, selectivity and sensitivity performance, even though the receiver suffers from strong out-of-band interference.

5.5.2 IF Filter

The signals coming from the RF front-end are filtered by the fully integrated 3rd-order band-pass image rejection IF filter which achieves over 35 dB image rejection ratio typically. The IF center frequency is dynamically adjusted to enable the IF filter to locate to the right frequency band, thus the receiver sensitivity and out-of-band interference attenuation performance are kept optimal despite the manufacturing process tolerances. The IF bandwidth is automatically computed according to the three basic system parameters input from the RFPDK: RF frequency, Xtal tolerance, and symbol rate.

5.5.3 RSSI

The subsequent multistage I/Q Log amplifiers enhance the output signal from IF filter before it is fed for demodulation. Receive Signal Strength Indicator (RSSI) generators are included in both Log amplifiers which produce DC voltages that are directly proportional to the input signal level in both of I and Q path. The resulting RSSI is a sum of both these two paths. Extending from the nominal sensitivity level, the RSSI achieves over 66 dB dynamic range.

The RFM219S integrates a patented DC-offset cancellation engine. The receiver sensitivity performance benefits a lot from the novel, fast and accurate DC-offset removal implementation.

5.5.4 SAR ADC

The on-chip 8-bit SAR ADC digitalizes the RSSI output. When receiving a FSK or GFSK modulated signal, the digitized RSSI is used to turn on and off the (G)FSK demodulator. When receiving an OOK modulated signal, it is used for OOK demodulation in the digital domain.

5.5.5 Crystal Oscillator

The crystal oscillator is used as the reference clock for the PLL frequency synthesizer and system clock for the digital blocks. A 26 MHz crystal should be used with appropriate loading capacitors (C2 and C3 in Figure 9, Page 11). The values of the loading capacitors depend on the total load capacitance C_L specified for the crystal. The total load capacitance seen between the XIN and XOUT pin should equal C_L for the crystal to oscillate at 26 MHz.

$$C_L = \frac{1}{\frac{1}{C_2} + \frac{1}{C_3}} + C_{parasitic}$$

The parasitic capacitance is constituted by the input capacitance and PCB tray capacitance. The ESR of the crystal should be within the specification in order to ensure a reliable start-up. An external signal source can easily be used in place of a conventional XTAL and should be connected to the XIN pin. The incoming clock signal is recommended to have a peak-to-peak swing in the range of 300 mV to 700 mV and AC-coupled to the XIN pin.



5.5.6 Frequency Synthesizer

A fractional-N frequency synthesizer is used to generate the LO frequency for the down conversion I/Q mixer. The frequency synthesizer is fully integrated except the VCO tank inductor which enables the ultra low-power receiver system design. Using the 26 MHz reference clock provided by the crystal oscillator or the external clock source, it can generate any receive frequency between 300 to 960 MHz with a frequency resolution of 24.8 Hz.

The VCO always operates at 2x of LO frequency. A high Q (at VCO frequency) tank inductor should be chosen to ensure the VCO oscillates at any conditions meanwhile burns less power and gets better phase noise performance. In addition, properly layout the inductor matters a lot of achieving a good phase noise performance and less spurious emission. The recommended VCO inductors for different LO frequency bands are shown as bellow.

Table 11. VCO Inductor for Common Used Frequency Bands

| LO Frequency Band (MHz) | 315 | 433.92 | 868.35 | 915 |
|-------------------------|-----|--------|--------|-----|
| VCO Inductor (nH) | 33 | 22 | 3.9 | 3.9 |

Multiple subsystem calibrations are performed dynamically to ensure the frequency synthesizer operates reliably in any working conditions.

5.5.7 LPOSC

An internal 1 kHz low power oscillator is integrated in the RFM219S. It generates a clock to drive the sleep timer to periodically wake the device up from sleep state. The Sleep Time can be configured from 3 to 134,152,192 ms (more than 37 hours) when the device works in duty-cycle receive mode. Since the frequency of the LPOSC drifts when the temperature and supply voltage change, it is automatically calibrated during the PUP state, and is periodically calibrated since then. The calibration scheme allows the LPOSC to maintain its frequency tolerance to less than ±1%.

5.5.8 OOK Demodulation

The OOK demodulation is done by comparing the RSSI to a demodulation threshold. The threshold is an 8-bit binary value that is comparable to the 8-bit digitized RSSI. There are two methods of OOK demodulation supported: Fixed TH and Peak TH. The symbol rate range for the OOK demodulation is from 0.1 to 40 ksps. More details of the OOK demodulation can be found in the document "AN138 RFM219S Configuration Guideline".

5.5.9 (G)FSK Demodulation

High-performance (G)FSK demodulation is supported. The symbol rate range for the (G)FSK demodulation is from 0.1 to 100 ksps. The device supports a wide range of deviations. The deviation is the maximum instantaneous difference between the modulated frequency and the nominal carrier frequency Fo.

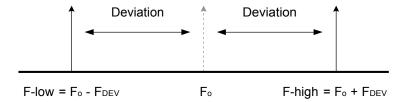


Figure 12. (G)FSK Deviation

A proper selection of the deviation is regarding to the modulation index and the frequency error between the TX and the RX. The



modulation index is given by:

Modulation Index =
$$\frac{\text{Deviation x 2}}{\text{Symbol Rate}}$$

The value of crystal tolerance dominates the frequency error:

By obeying the following rules, the RFPDK automatically computed the minimum value of the deviation that can be configured.

This means the Modulation Index cannot be less than 1. Also, the deviation must be larger than the frequency error in order to guarantee the reception. The RFPDK also computes the maximum value of the deviation that can be configured. The following rule is obeyed:

Therefore, once the Symbol Rate and Xtal Tolerance are configured on the RFPDK, the configurable range of the Deviation is automatically obtained.

On the other hand, the FSK demodulation can be automatically turned on and off by detecting the RSSI relative thresholds to save the power consumption of the device. Automatic Frequency Control (AFC) can be used by the user to minimize/remove the frequency error between the Tx and the Rx. More details of the (G)FSK demodulation can be found in the document "AN138 RFM219S Configuration Guideline".

5.6 SPI Interface

The communication between the MCU and the chip is done via the 4-wire SPI interface. The active-low CSB indicates that the MCU is trying to access to the registers. The active-low FCSB indicates that the MCU is trying to read the FIFO. The CSB and FCSB cannot be both set low at the same time. The SCL is the serial clock. For both of the MCU and the chip, data is always sent at the falling edge of SCL and captured at the rising edge of SCL. The SDA is a bi-directional data pin. Address and data is always sent starting from the MSB.

5.6.1 Register Read & Write Operation

While accessing to the registers, an r/w bit is sent followed by a 7-bit register address. The MCU must pull the CSB to low at least half SCL cycle before sending the r/w bit. After issuing the last falling edge of SCL, the MCU must wait for at least half SCL cycle before pulling the CSB back to high.



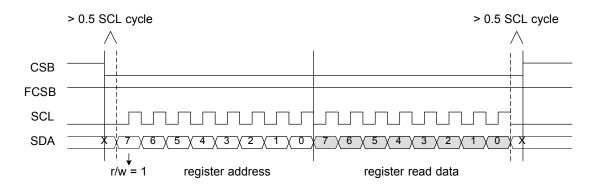


Figure 13. SPI Read Register Timing

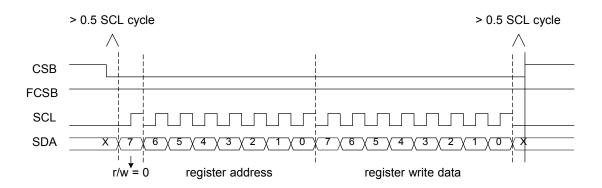


Figure 14. SPI Write Register Timing

5.6.2 FIFO Read Operation

When reading the 32-byte FIFO, the internal read pointer will automatically increment after each byte is read out. The MCU must pull the FCSB to low for at least 1 SCL cycle before issuing the first rising edge of SCL. After issuing the last falling edge of SCL, the MCU must wait for at least 2 us before pulling the FCSB back to high. Furthermore, the MCU must pull up the FCSB for at least 4 us before reading the next byte of the FIFO. It allows the internal circuit to generate the FIFO interrupts according to the current status.

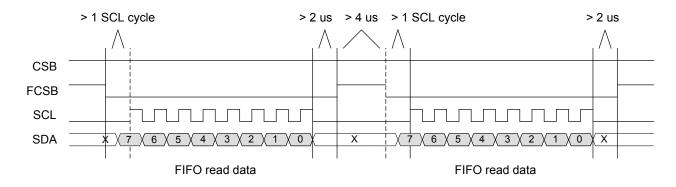


Figure 15. SPI Read FIFO Timing

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5.7 Operation States, Timing and Power

5.7.1 Power-Up Sequence

The chip operation starts from a valid power-on reset. It usually takes about 0.5 ms for the valid power-on reset to release. Once the POR is released the crystal oscillator start oscillating. The time taken for the crystal oscillator to get stable is fixed at 2.5 ms in the first power-up. After the crystal gets stable, it takes about 6.5 ms for the chip to perform the internal blocks calibrations. The calibrations are only performed once at the beginning of one power-on cycle.

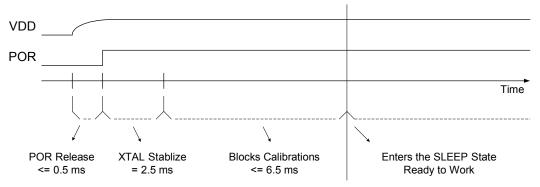


Figure 16. Power-Up Sequence Timing

The chip enters the SLEEP mode as soon as the calibrations are done. From this point on, the MCU can then actively switch the chip into different operating states by writing the register bits OP_SWITCH<4:0>.

5.7.2 Operating States

There are in all 6 operating states: PUP, SLEEP, STBY, TUNE, RX and EEPROM, as shown in the below table.

| State | Command | Active Blocks | Optional Blocks |
|--------|------------|---------------------------|--------------------|
| PUP | soft_reset | POR, XTAL | None |
| SLEEP | go_sleep | SPI, POR | LFOSC, Sleep Timer |
| STBY | go_stby | SPI, POR, XTAL, FIFO | CLKO |
| TUNE | go_tune | SPI, POR, XTAL, PLL, FIFO | CLKO |
| RX | go_rx | All | CLKO, RX Timer |
| EEPROM | go_eeprom | SPI, POR, XTAL | CLKO |

Table 12. RFM219S Operation States

The 6 commands used by the MCU to switch the states are simply register-writing operation. Please see OP_CTRL and SOFTRST register description for the details. The MCU can arbitrarily switch the states, as long as it complies with the switching time requirement and rules. For example, the MCU can directly switch the chip from SLEEP state to RX state, while it has to wait for the time of "Xtal Stabilizing Time + 300 us + 20 us" before taking any further actions in the RX state. While switching the states backward, the time cost is negligible. Switching to the EEPROM state is only allowed in the SLEEP state. The soft reset will pull the device back to the PUP state and re-perform the blocks calibrations.

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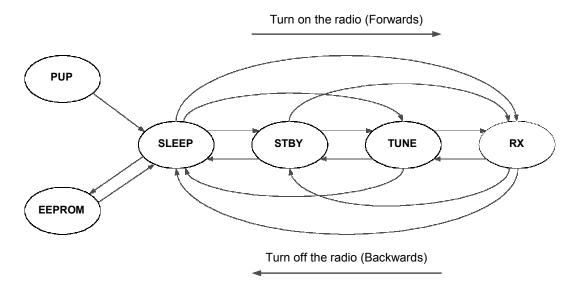


Figure 17. Device Operating State Machine

The below figure shows the switching time for a typical receive cycle, starting from the SLEEP mode. The power consumption is also shown in the figure. They are measured when the device works in 868.35 MHz using FSK demodulation, with the Sleep Timer turned off.

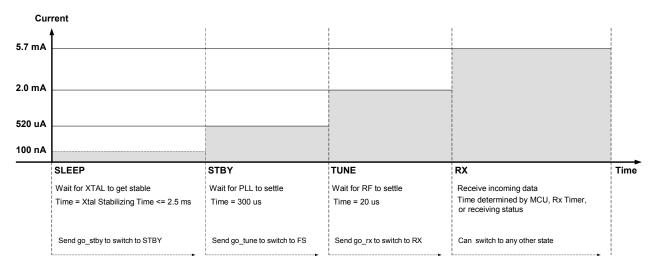


Figure 18. Timing and Power from SLEEP to RX state

Power Up (PUP) State

Once the device is powered up, it will go through the Power Up (PUP) sequence which includes the task of releasing the Power-On Reset (POR), turning on the crystal and calibrating the internal blocks. The PUP takes about 9.5 ms to finish. After that the device is automatically switched to the SLEEP state.

SLEEP State

Most of the internal blocks are powered down including the crystal oscillator to save power. The SPI interface and control registers are accessible. The FIFO is not accessible. The optional LPOSC and sleep timer can be turned on if the parameter of 'Sleep Timer On-Off' is set to 'On' on the RFPDK. The sleep current is less than 60 nA when the sleep timer is turned off and 440 nA when it is turned on.

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STBY State

The crystal oscillator is turned on. The frequency synthesizer and RF front-end are turned off. The FIFO contents retain in the STBY state. If the sleep timer is turned on, after the sleep timer timeout the chip is automatically switched to the STBY state and waits for the MCU's commands. It takes the time defined by the "Xtal Stabilizing Time" on the RFPDK for the device to switch from the SLEEP state to the STBY state. The power consumption is about 520 uA in the STBY state.

TUNE State

The frequency synthesizer (PLL) is tuned and locked to the desired frequency. The RF front-end is turned off. The FIFO contents retain in the TUNE state. It takes about 300 us to switch from the STBY state to the TUNE state. The power consumption is about 2 mA in the TUNE state.

RX State

All the blocks are turned on. The chip will receive the incoming signals, output the demodulated data from the GPO pin which is configured as DOUT or perform the data decoding and buffering with the packet handler and the FIFO. The power consumption of the RX state depends on the frequency band and the demodulation methods. It only takes about 20 us to switch from the TUNE state to the RX state.

EEPROM State

This state is designed for the user to get access to the User Space of the EEPROM. The User Space is a 32-byte free space that allows the users to store their own information. The User Space is independent from the Configuration Space which is used to store all the parameters downloaded from the RFPDK. The details about how to get access to the User Space can be found in the" AN136 Accessing the RFM219S EEPROM".

5.8 GPOs and Interrupts

Four General Purpose Outputs (GPOs) are available to use.

Pin I/O Name **Function** GPO1 0 Programmable output, options are: nRSTO (default), INT1, INT2 and DOUT 13 GPO2 Programmable output, options are: INT1 (default), INT2 and DCLK 12 0 GPO3 0 Programmable output, options are: CLKO (default), INT1, INT2 and DOUT GPO4 Programmable output, options are: DOUT (default), INT1, INT2 and DCLK

Table 13. General Purpose Outputs

The nRSTO and the CLKO are respectively the POR and clock output to drive the external MCU. They are designed to lower the system application BOM. The DOUT is the demodulated data output and the DCLK is the sync clock output.

The INT1 and INT2 are the two interrupt outputs which response to multiple sources, as listed in table below.

Table 14. Interrupt Sources

| Interrupts | Descriptions | Clearing Methods |
|------------|--|------------------|
| RSSI_VLD | The RSSI valid interrupt | By External MCU |
| PREAM_VLD | The preamble detection interrupt | By External MCU |
| SYNC_PS | The sync word detection interrupt | By External MCU |
| NODE_PS | The node ID detection interrupt in packet mode | By External MCU |
| CRC_PS | The CRC validation successful interrupt in packet mode | By External MCU |
| PKT_DONE | The packet receiving done interrupt in packet mode | By External MCU |
| SL_TMO | The sleep timer timeout interrupt | By External MCU |



| Interrupts | Descriptions | Clearing Methods |
|------------|---|------------------|
| RX_TMO | The receive timer timeout interrupt | By External MCU |
| FIFO_NMTY | The FIFO not-empty interrupt | Auto |
| FIFO_TH | The FIFO threshold-reach interrupt | Auto |
| FIFO_FULL | The FIFO full interrupt | Auto |
| FIFO_WBYTE | The FIFO write-byte interrupt | Auto |
| FIFO_OVF | The FIFO overflow interrupt | Auto |
| RSSI_INDI | The real-time RSSI indication interrupt | Auto |

All the interrupts are active-high. The figure below gives an example of how the multiple interrupts sources are multiplexed to the INT1, and then assigned to the GPOs in the packet mode. The INT2 has the similar mapping but is selected by INT2_CTL<3:0>.

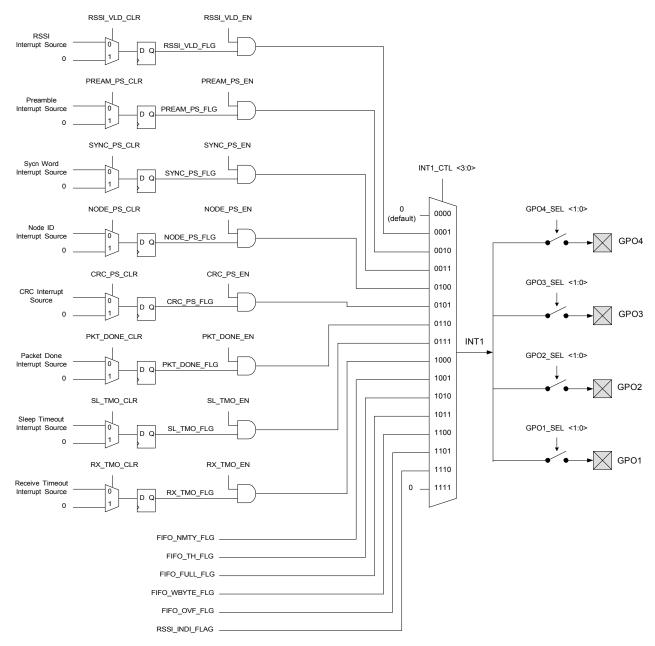


Figure 19. INT1 Multiplexing and Controls



For those which are cleared by the MCU, each of them has an 'EN' bit and a 'CLR' register bit. For example, the Sync Word detection pass interrupt is only enabled when the 'SYNC_PS_EN' bit is set to 1, and the interrupt is cleared by setting the 'SYNC_PS_CLR' bit to 1. The MCU does not need to set the 'SYNC_PS_CLR' bit back to 0 after setting it to 1, because this bit automatically clears itself once the interrupt is cleared.

The number of available interrupts and their mappings are different in direct mode and buffer mode. For more details of the GPO controls, please refer to chapter 5.11 User Registers.

5.9 Data Handling

A data path consists of a packet handler and a 32-byte FIFO which is responsible for delivering the data from the demodulator to the external MCU. It supports 3 data access modes: direct, buffer and packet mode.

5.9.1 Direct Mode

In direct mode, the data from the demodulator's output is directly sent out to the MCU via the DOUT, which can be mapped to GPO 1, 3 or 4. The synchronization clock is output via the DCLK, which can be mapped to GPO 2 or 4. The optional preamble and sync word detection interrupts are supported upon requirements.

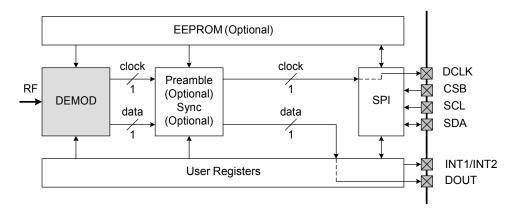


Figure 20. Data Path of Direct Mode

The data receiving works independently of the preamble and sync word detection in the direct mode. This means, no matter whether a valid preamble or a sync word is detected or not, the demodulated data will be transparently output on the DOUT.

The sync clock is generated with two purposes: removing the glitches exist on the data output, and assisting the external MCU to sample the data at the correct instance.

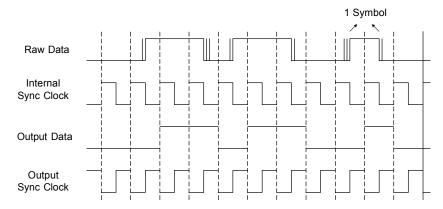


Figure 21. Demodulated Data and Sync Clock Timing Characteristics

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In the figure above, the raw data is the output of the demodulator. When the SNR of the incoming signal is very low, glitches possibly exist on the raw data. The device will remove those glitches by internally sampling the raw data using the recovered clock. The clean data is output to the DOUT. The sync clock is delayed by half cycle and output to the DCLK. The rising edge of the output sync clock is centered on the output data. If the sync clock is turned off, the raw data will be directly output to the DOUT.

The sync clock generator produces the clock according to the symbol rate configured on the RFPDK. It can tolerate a certain amount of symbol rates offset existing between the real incoming signal and the symbol rate input on the RFPDK.. For more details of the symbol rate offset tolerance, please refers to the "AN138 RFM219S Configuration Guideline".

5.9.2 Buffer Mode

In buffer mode, the data from the demodulator's output are shifted into the 32 x 8-bit parallel FIFO after a valid sync word is detected. The MCU can use the SPI to read the FIFO. The FIFO will retain its content and be readable in the STBY, TUNE and RX state. The MCU can use the FIFO interrupts to assist to the FIFO reading. The optional preamble detection is supported.

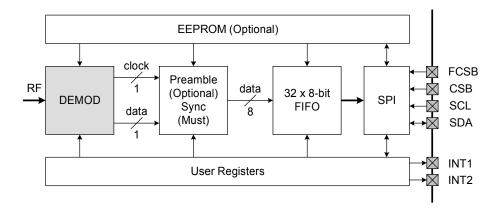


Figure 22. Data Path of Buffer Mode

Because the chip does all the data buffering work, the MCU can spend time on the other tasks during the buffering process. Also, it reduces the MCU's performance requirement in terms of speed and reactivity. The data receiving is independent of the preamble detection, while the sync word detection is compulsory in the buffer mode.

5.9.3 Packet Mode

In packet mode, the data from the demodulator's output are first shifted into the packet handler to get decoded, and then filled into the 32×8 -bit parallel FIFO.

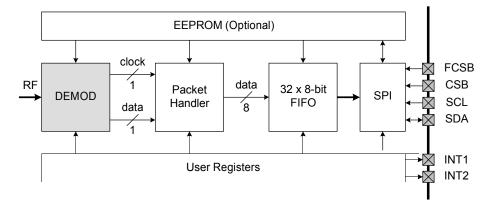


Figure 23. Data Path of Packet Mode

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Similar to the buffer mode, the data are obtained by reading the FIFO. The packet handler provides various options of decoding and validating the incoming data. This can further reduce the work load and user program size of the MCU.

Packet Type: Fixed Length

The fixed length means that the payload length is configured into the device and will not be changed during the transmission. The RX and TX shall have the same payload length in this case. The payload contains the optional Node ID and the Data. The maximum payload length is limited to the FIFO size which is 32 bytes.

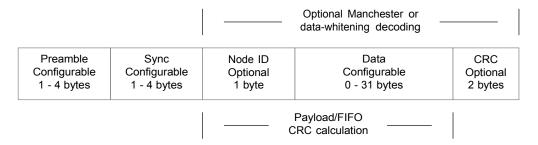


Figure 24. Fixed Length Packet Structure

Packet Type: Variable Length

The variable length means that the payload length can vary in different frames. In this case, an additional "Length" byte is given as the part of the payload to indicate the payload length of the current frame. The maximum payload length can be indicated by the Length byte is 31, because the Length byte itself is not included in the calculation. For example, if the Length byte indicates that the payload is 31 bytes, and the Node ID is supported, it means that there will be 1 byte of Node ID and 30 bytes of Data incoming.

If the Length byte indicates that the payload length is larger than 31, which exceeds the maximum size of the FIFO minus 1, the current packet will be discarded by the device and the Data will not be shifted into the FIFO.

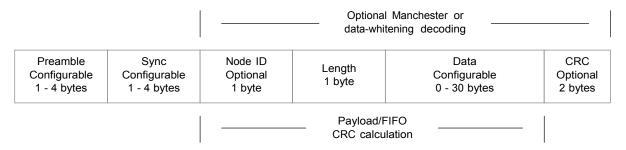


Figure 25. Variable Length Packet Structure

For more details of the FIFO and configuring each component of the packet handler, please refer to the "AN138 RFM219S Configuration Guideline".

5.10 Receiver Operation Control

Multiple options, which can be seen in "Table 10 – Operating Setting", are available for the user to design different operating behavior of the device. The main purpose of this is to save the power consumption of the system. It can be seen that the device contains a sleep timer and a receive timer. Also, the device supports the well-known wake-on radio (WOR) operation. Please refer to the document "AN138 RFM219S Configuration Guideline" for the details introduction of the operation settings.

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5.11 User Registers

The user registers are all 8-bit width. There are two banks of the user registers: Configuration Bank and Control Bank.

5.11.1 Configuration Bank

The configuration bank has the address from 0x00 to 0x3D. This bank of registers provides an option to configure the feature of the device. The way to do that is: use the RFPDK to generate the HEX file of the desired configurations, load the file into the external MCU program, and the MCU program will write the content of HEX file into all these registers via the SPI at the beginning of the application. This bank will only have to be written once in the application. The contents of these registers retain their values until the power down of the device, and they will not be reset by the soft reset operation.

If the Sync Word recognition is done by the device in the application, the 4 configuration registers below, which store the value of the 32-bit (maximum size) Sync Word, might have different values in different devices. Therefore, in that case, the value of the Sync Word for each device does not come from the HEX file generated by the RFPDK, but the external MCU program. After writing the content of the HEX file into the entire configuration bank, the MCU is able to overwrite these 4 registers with the unique Sync Word at the beginning of the application.

| Name | Addr | Default | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|--------|------|---------|--------|-------------------|-----------|-----------|-----------|-------|-------|-------|
| SYNC_A | 0x16 | 0x00 | | Sync Word <7:0> | | | | | | |
| SYNC_B | 0x17 | 0x00 | | Sync Word <15:8> | | | | | | |
| SYNC_C | 0x18 | 0x00 | | Sync Word <23:16> | | | | | | |
| SYNC_D | 0x19 | 0x00 | | | | Sync Word | d <31:24> | | | |
| DC_CTL | 0x1F | 0x00 | DC En | LFOSC M | ode <1:0> | NA | NA | NA | NA | NA |
| SL_CTL | 0x23 | 0x00 | SLP En | NA | NA | NA | NA | NA | NA | NA |
| RX_CTL | 0x25 | 0x00 | RX En | NA | NA | NA | NA | NA | NA | NA |

Table 15. Sync Word Registers

If EEPROM programming is used to configure the device, this configuration bank of user registers must NOT be written in the MCU program, with the exception of the 4 Sync Word registers introduced above.

The "DC En", "LFOSC Mode<1:0>", "SLP En" and "RX En" bits provide the flexibility for the user to manually turn on/off the duty cycle mode, as well as the sleep timer and the receive timer. The other NA bits of these registers must not be changed by the external MCU.

A typical application is that, the device is configured to work in the passive mode by the RFPDK. After the power-up process the device enters the sleep state, in which the external MCU can setup the control bank registers of the device. After that, the MCU uses the above register bits to manually turn on the duty cycle mode. The device then automatically works in the duty-cycle mode without the need of any external control. The MCU can disable the duty-cycle mode of the device any time when it is necessary. The details of how to use these bits to turn on/off the duty-cycle mode is given in the application note "AN138 RFM219S Configuration Guideline".

5.11.2 Control Bank

Ten registers are available for the user to control the chip in the MCU program. Their functions are summarized as below.

- Registers those have the address from 0x3F to 0x44 provide the interface to control the GPO and interrupts.
- Register that has the address 0x45 allows the user to read out the instantiate RSSI value.
- Register that has the address 0x46 allows the user to disable/enable a couple of specific functions.



- Register that has the address 0x47 allows the user to set and verify the operation modes.
- Register that has the address 0x4F is dedicated to the soft reset command.

Table 16. Control Bank Registers

| Name | Addr | Default | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|----------|------|---------|-------------------------------|------------------------|---------------|-------------|--------------|---------------|---------------|--------------|
| INT_EN | 0x3F | 0x00 | SL_TMO_EN | RX_TMO_EN | RSSI_VLD_EN | PREM_PS_EN | NODE_PS_EN | SYNC_PS_EN | CRC_PS_EN | PKT_DONE_EN |
| IO_SEL | 0x40 | 0x00 | GPO4_5 | GPO4_SEL<1:0> GPO3_SEI | | | GPO2_S | EL<1:0> | GPO1_SEL<1:0> | |
| INTCTL_A | 0x41 | 0x00 | | INT2_CTL<3:0> | | | | INT1_CTL<3:0> | | |
| INTCTL_B | 0x42 | 0x00 | SL_TMO_CLR | RX_TMO_CLR | RSSI_VLD_CLR | PREM_PS_EN | NODE_PS_CLR | SYNC_PS_CLR | CRC_PS_CLR | PKT_DONE_CLR |
| INTCTL_C | 0x43 | 0x00 | SL_TMO_FLG | RX_TMO_FLG | RSSI_VLD_FLG | PREM_PS_FLG | NODE_PS_FLG | SYNC_PS_FLG | CRC_PS_FLG | PKT_DONE_FLG |
| INTCTL_D | 0x44 | 0x00 | RESV | FIFO_FULL_FLG | FIFO_NMTY_FLG | FIFO_TH_FLG | FIFO_OVF_FLG | FIFO_PKT_CLR | RESV | RESV |
| RSSI | 0x45 | 0x00 | | | | RSSI_VAL | UE<7:0> | | | |
| FUNC_EN | 0x46 | 0x04 | RESV | SLTIMER_STOP | PROD_TEST_EN | RESV | RESV | HS_SPI_EN | RESV | RESV |
| OP_CTRL | 0x47 | 0x00 | OP_STATUS<2:0> OP_SWITCH<4:0> | | | | | | | |
| SOFTRST | 0x4F | NA | | | | SOFT_R | ST<7:0> | | | |

The detailed descriptions of each register are given below.

Table 17. INT_EN Register

| Register | Bit | RW | Bit Name | Descriptions |
|----------|---------|-------------------|--|--|
| | 7 | w/s.c. | CL TMO EN | 0: Disable the sleep timer timeout interrupt (default). |
| | / | r/w | SL_TMO_EN | 1: Enable the sleep timer timeout interrupt. |
| | 6 | r/w | RX TMO EN | 0: Disable the receive timer timeout interrupt (default). |
| | 0 | 17 VV | KA_IWO_EN | 1: Enable the receive timer timeout interrupt. |
| | 5 | r/w | DOOL VIID EN | 0: Disable the RSSI valid interrupt (default). |
| | 5 | 17VV | RSSI_VLD_EN | 1: Enable the RSSI valid interrupt. |
| | 4 | r/w | PREAM PS EN | 0: Disable the preamble detection pass interrupt (default). |
| INT_EN | 4 | 17 VV | FREAW_F3_EN | 1: Enable the preamble detection pass interrupt. |
| (0x3F) | 3 | r/w | SYNC PS EN | 0: Disable the sync word detection pass interrupt (default). |
| | 7 | 17 VV | STNO_FS_EN | 1: Enable the sync word detection pass interrupt. |
| | 2 | r/w | NODE PS EN | 0: Disable the node ID detection pass interrupt (default). |
| | ۷ | 17 VV | NODE_F3_EN | 1: Enable the node ID detection pass interrupt. |
| | 1 | r/w | CRC_PS_EN | 0: Disable the CRC validation pass interrupt (default). |
| | I I I/W | ONO_FO_EN | 1: Enable the CRC validation pass interrupt. | |
| | 0 7/11 | 0 r/w PKT_DONE_EN | DKT DONE EN | 0: Disable the packet receive finish interrupt (default). |
| | U | | 1: Enable the packet receive finish interrupt. | |



Table 18. IO_SEL Register

| Register | Bit | RW | Bit Name | Descriptions |
|----------|-----|-----|---------------|---|
| | 7:6 | r/w | GPO4_SEL<1:0> | Select which signal is assigned to GPO4. 00: DOUT is output via GPO4 (default). 01: INT1 is output via GPO4. 10: INT2 is output via GPO4. 11: DCLK is output via GPO4. |
| IO_SEL | 5:4 | r/w | GPO3_SEL<1:0> | Select which signal is assigned to GPO3. 00: CLKO is output via GPO3 (default). 01: INT1 is output via GPO3. 10: INT2 is output via GPO3. 11: DOUT is output via GPO3. |
| (0x40) | 3:2 | r/w | GPO2_SEL<1:0> | Select which signal is assigned to GPO2. 00: INT1 is output via GPO2 (default). 01: INT2 is output via GPO2. 10: DCLK is output via GPO2. 11: logic '0' is output via GPO2. |
| | 10: | r/w | GPO1_SEL<1:0> | Select which signal is assigned to GPO1. 00: nRSTO is output via GPO1 (default). 01: INT1 is output via GPO1. 10: INT2 is output via GPO1. 11: DOUT is output via GPO1. |

Table 19. INCTL_A

| Register | Bit | RW | Bit Name | Descriptions | | | | | | | |
|----------|-----|---------|---------------|---|-------------|-------------|-------------|--|--|--|--|
| | | | | This allows the user to select which interrupt is observable on the INT The setting is different in the 3 different data modes. | | | | | | | |
| | | | | Value | Direct Mode | Buffer Mode | Packet Mode | | | | |
| | | | | 0000 | 0 | 0 | 0 | | | | |
| | | | | 0001 | RSSI_VLD | RSSI_VLD | RSSI_VLD | | | | |
| | | | | 0010 | PREAM_PS | PREAM_PS | PREAM_PS | | | | |
| | | | | 0011 | SYNC_PS | SYNC_PS | SYNC_PS | | | | |
| | | 7:4 r/w | | 0100 | SL_TMO | SL_TMO | NODE_PS | | | | |
| INTCTL_A | | | INTO OTI O | 0101 | RX_TMO | RX_TMO | CRC_PS | | | | |
| (0x41) | /:4 | | INT2_CTL<3:0> | 0110 | RSSI_INDI | FIFO_NMTY | PKT_DONE | | | | |
| | | | | 0111 | 0 | FIFO_TH | SL_TMO | | | | |
| | | | | 1000 | 0 | FIFO_FULL | RX_TMO | | | | |
| | | | | 1001 | 0 | FIFO_WBYTE | FIFO_NMTY | | | | |
| | | | | 1010 | 0 | FIFO_OVF | FIFO_TH | | | | |
| | | | | 1011 | 0 | RSSI_INDI | FIFO_FULL | | | | |
| | | | | 1100 | 0 | 0 | FIFO_WBYTE | | | | |
| | | | | 1101 | 0 | 0 | FIFO_OVF | | | | |
| | | | | 1110 | 0 | 0 | RSSI_INDI | | | | |



| | | | The details of each interrupt are introduced in the registers INTCTL_B, INTCTL_C and INTCTL_D. |
|-----|-----|---------------|---|
| | | | The FIFO_WBYTE is the FIFO write-byte strobe that pulses up when each byte is filled into the FIFO. Because it is a pulse, It cannot be seen in the INTCTL_C register which reflects the interrupt flags. |
| 3:0 | r/w | INT1_CTL<3:0> | This allows the user to select which interrupt is observable on the INT1. The interrupt mapping is identical to that of the INT2. |

Table 20. INTCTL_B

| Register | Bit | RW | Bit Name | Descriptions |
|-------------------------|--|-----|--------------|---|
| | 7 | 147 | SL TMO CLD | 0: Keep the sleep timer timeout interrupt (default). |
| | , | W | SL_TMO_CLR | 1: Clear the sleep timer timeout interrupt. |
| | 6 | w | RX TMO CLR | 0: Keep the receive timer timeout interrupt (default). |
| | 0 | VV | KX_TWO_CLK | 1: Clear the receive timer timeout interrupt. |
| | 5 | w | RSSI VLD CLR | 0: Keep the RSSI valid interrupt (default). |
| | 5 | VV | RSSI_VLD_CLR | 1: Clear the RSSI valid interrupt. |
| | 4 | w | DDEAM DC CLD | 0: Keep the preamble detection pass interrupt (default). |
| INTCTL_B ^[1] | NTCTL_B ^[1] ⁴ ^w | VV | PREAM_PS_CLR | 1: Clear the preamble detection pass interrupt. |
| (0x42) | 3 | 147 | SYNC_PS_CLR | 0: Keep the sync word detection pass interrupt (default). |
| | 3 | W | | 1: Clear the sync word detection pass interrupt. |
| | 2 | w | NODE DO CLD | 0: Keep the node ID detection pass interrupt (default). |
| | | VV | NODE_PS_CLR | 1: Clear the node ID detection pass interrupt. |
| | 1 | | CDC DC CLD | 0: Keep the CRC validation pass interrupt (default). |
| | I | W | CRC_PS_CLR | 1: Clear the CRC validation pass interrupt. |
| | 0 | 147 | DVT DONE OLD | 0: Keep the packet receive finish interrupt (default). |
| | U | W | PKT_DONE_CLR | 1: Clear the packet receive finish interrupt. |
| Note: | | | | |

Note:

Table 21. INTCTL_C

| Register | Bit | RW | Bit Name | Descriptions |
|----------|-----|----|--------------|--|
| | 7 | r | SL TMO FLG | This interrupt is generated when the sleep timer is turned on and the SL TMO EN is set to 1. The flag goes high at the sleep timer timeout. It |
| | · | | 02_10_1 20 | can be cleared by setting the SL_TMO_CLR to 1. |
| | | | RX_TMO_FLG | This interrupt is generated when the receive timer is turned on and the |
| INTCTL_C | 6 | r | | RX_TMO_EN is set to 1. The flag goes high at the receive timer timeout. |
| (0x43) | | | | It can be cleared by setting the RX_TMO_CLR to 1. |
| | | | | This interrupt is generated when (G)FSK demodulation is used and the |
| | 5 | r | Deel VID ELC | RSSI_VLD_EN is set to 1. The flag goes high when the RSSI exceeds |
| | 5 | 1 | RSSI_VLD_FLG | the FSK Trigger Threshold. It can be cleared by setting the |
| | | | | RSSI_VLD_CLR to 1. |

^{[1].} Every bit in this register only takes effect in STBY, TUNE, RX and EEPROM state.



| | 4 | r | PREAM_PS_FLG | This interrupt is generated when the preamble validation is passed and the PREAM_PS_EN is set to 1. It can be cleared by setting the PREAM_PS_CLR to 1. |
|--|---|---|--------------|--|
| | 3 | r | SYNC_PS_FLG | This interrupt is generated when the sync word validation is passed and the SYNC_PS_EN is set to 1. It can be cleared by setting the SYNC_PS_CLR to 1. |
| | 2 | r | NODE_PS_FLG | This interrupt is generated when the node ID validation is passed in the packet mode and the NODE_PS_EN is set to 1. It can be cleared by setting the NODE_PS_CLR to 1. |
| | 1 | r | CRC_PS_FLG | This interrupt is generated when the CRC validation is passed in the packet mode and the CRC_PS_EN is set to 1. It can be cleared by setting the CRC_PS_CLR to 1. |
| | 0 | r | PKT_DONE_FLG | This interrupt is generated when a packet is received (regardless of the CRC validation) in the packet mode and the PKT_DONE_EN is set to 1. It can be cleared by setting the PKT_DONE_CLR to 1. |

Table 22. INTCTL_D

| Register | Bit | RW | Bit Name | Descriptions |
|--------------------|-----|-----|---------------|--|
| | 7 | r | RESV | This bit is reserved. |
| | 6 | r | FIFO_FULL_FLG | This interrupt is generated in the FIFO Mode and Packet Mode. The flag goes high when the FIFO is full. It is cleared automatically when the FIFO is not full. |
| | 5 | r | FIFO_NMTY_FLG | This interrupt is generated in the FIFO Mode and Packet Mode. The flag goes high when the FIFO is found to be not empty (the number of unread data byte is not zero). It is cleared automatically when the FIFO is empty. |
| INTCTL_D (0x44) | 4 | r | FIFO_TH_FLG | This interrupt is generated in the FIFO Mode and Packet Mode. The flag goes high when the number of unread data bytes reaches/exceeds the value defined in the "FIFO Threshold" parameter. It is cleared automatically when the number of unread data bytes is less than the "FIFO Threshold". |
| | 3 | r | FIFO_OVF_FLG | This interrupt is generated in the FIFO Mode and Packet Mode. The flag goes high when the FIFO is overflow. It is cleared automatically when the FIFO is not overflow. |
| | 2 | w | FIFO_PKT_CLR | O: Keep the FIFO content (default). 1: Clear the FIFO content. Note: This bit only takes effect in the STBY, TUNE, RX and EEPROM state. In the SLEEP state, the FIFO and packet handler is automatically cleared and reset. |
| | 1 | r/w | RESV | Must always set to 0. |
| | 0 | r/w | RESV | Must always set to 0. |



Table 23. RSSI

| Register | Bit | RW | Bit Name | Descriptions |
|----------------|-----|----|-----------------|--|
| RSSI (0x45) | 7:0 | r | RSSI_VALUE<7:0> | The value immediately reflects the real time Radio Signal Strength Indicator (RSSI) when the chip is working in the RX state. The value is low-pass filtered by the chip before it is read out. Thus any high-frequency noise in the RSSI cannot be seen by the user. The RSSI of any signal that is weaker than the "Squelch Threshold" will be masked, i.e. the RSSI value is read as 0. |

Table 24. FUNC_EN

| Register | Bit | RW | Bit Name | Descriptions |
|-------------------|-----|-----|--------------|--|
| | 7 | r/w | RESV | Always set it to 0. |
| | 6 | r/w | SLTIMER_STOP | During manufacturing stage, a few steps are required to perform to enter the test mode. Stopping the running sleep timer is one of those steps (see Chapter Manufacturing Test for details). 0: Do not disturb the sleep timer (default). |
| | | | | 1: Stop the sleep timer. |
| FUNC_EN (0x46) | 5 | r/w | PROD_TEST_EN | During manufacturing stage, a few steps are required to perform to enter the test mode. Setting this bit to 1 is one of those steps (see Chapter Manufacturing Test for details). 0: Disable the manufacturing test mode (default). 1: Enable the manufacturing test mode. |
| , , | 4 | r/w | RESV | Always set it to 0. |
| | 3 | r/w | RESV | Always set it to 0. |
| | 2 | r/w | HS_SPI_EN | To minimize the power consumption the maximum SPI clock speed is 400 kHz. The user can used this bit to allow up to 1MHz SPI speed supported. 0: Support maximum SPI clock speed of 400 kHz (default). 1: Support maximum SPI clock speed of 1 MHz. |
| | 1 | r/w | RESV | Always set it to 0. |
| | 0 | r/w | RESV | Always set it to 0. |



Table 25. OP_CTRL

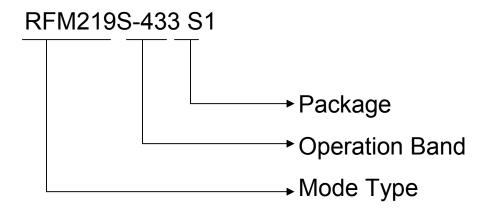
| Register | Bit | RW | Bit Name | Descriptions |
|-------------------|-----|-----|----------------|---|
| OP_CTRL (0x47) | 7:5 | r | OP_STATUS<4:0> | This allows the user to read out the chip operating state. 000: PUP state. 001: SLEEP state (Default). 010: STBY state. 011: TUNE state. 100: RX state. 101: EEPROM state. Normally after the POR and power-up sequence, the chip stays in the SLEEP state. If the POR is failed, the chip stays in the PUP state. The user is not able to switch to chip to the PUP state in normal operation. |
| | 4:0 | r/w | OP_SWITCH<4:0> | This allows the user to switch the chip operating states. 00001: go_eeprom command, switch to EEPROM state. 10000: go_sleep command, switch to SLEEP state. 00010: go_stby command, switch to STBY state. 00100: go_tune command, switch to TUNE state. 01000: go_rx command, switch to RX state. Setting this register to any values other than the following 5 values will not take any effect. |

Table 26. SOFTRST

| Register | Bit | RW | Bit Name | Descriptions |
|-------------------|------|----|---------------|--|
| SOFTRST (0x4F) | 0x3F | w | SOFT_RST<7:0> | Writing 0xFF into this register will generate a soft_reset command to the device. Setting this register to any values other than 0xFF will not take any effect. The soft reset has the same effect of POR. After the soft reset, the chip will go through the power-up sequence and then enter the SLEEP Mode. After soft resetting the chip, the MCU shall wait 10 ms before performing any other controls to the chip. |



6. Ordering Information



P/N: RFM219S-315S1

RFM219S module at 315MHz band, SMD Package

P/N: RFM219S-433S1

RFM219S module at 433.92MHz band,SMD Package,



7. Package Outline

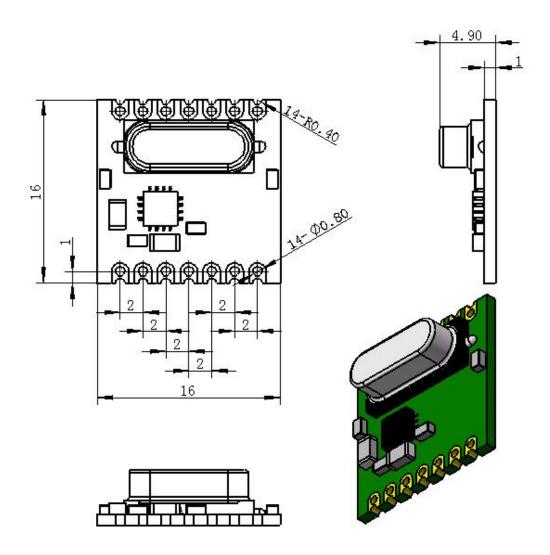


Figure 13 S1 Package Outline Drawi



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